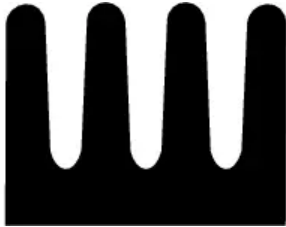


Data sheet Product ICK SMD A 10 MI



Heatsinks and active heatsinks for processors>Heatsinks for DIL-IC, PLCC and SMD

6,3 x 4,8 mm, for SMD components and others

Features

width:	6.3 mm
height:	4.8 mm
plate thickness:	1 mm
length:	10 mm
thermal resistance:	75 K/W
surface:	solderable surface

Technical Drawing

